MOSFET - N-Channel, **SUPERFET® II**

800 V, 58 A, 60 m Ω

FCH060N80

Description

SUPERFET II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

Features

- Typ. $R_{DS(on)} = 54 \text{ m}\Omega$
- $850 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Ultra Low Gate Charge (Typ. Q_g = 270 nC)
- Low E_{OSS} (Typ. 23 μJ @ 400 V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 981 pF)
- 100% Avalanche Tested
- This Device is RoHS Compliant

Applications

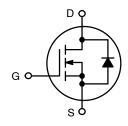
- AC-DC Power Supply
- LED Lighting



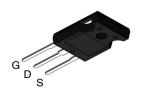
ON Semiconductor®

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V _{DSS}	R _{DS(ON)} MAX	I _D MAX
800 V	60 mΩ @ 10 V	58 A

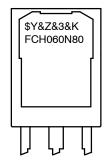


POWER MOSFET



TO-247-3LD CASE 340CH

MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Numeric Date Code &K = Lot Code

FCH060N80 = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$, Unless otherwise noted)

Symbol	Parameter	Value	Unit	
V _{DSS}	Drain to Source Voltage		800	V
V _{GSS}	Gate to Source Voltage	DC	±20	V
		AC (f > 1 Hz)	±30	
I _D	Drain Current	Continuous (T _C = 25°C)	58	Α
		Continuous (T _C = 100°C)	36.8	
I _{DM}	Drain Current	Pulsed (Note 1)	174	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	2317	mJ	
I _{AS}	Avalanche Current (Note 1)		11.6	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		50	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P _D	Power Dissipation	(T _C = 25°C)	500	W
		Derate Above 25°C	4	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose 1/8" from Case for 5 seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
1. Repetitive rating: pulse width limited by maximum junction temperature.
2. $I_{AS} = 11.6 \text{ A}$, $V_{DD} = 50 \text{ V}$, $R_{G} = 25 \Omega$, starting $T_{J} = 25^{\circ}\text{C}$.
3. $I_{SD} \le 58 \text{ A}$, $di/dt \le 200 \text{ A/µs}$, $V_{DD} \le BV_{DSS}$, starting $T_{J} = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Max.	0.25	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH060N80-F155	FCH060N80	TO-247-3LD	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS		•	1		
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}\text{C}$	800			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C		0.8		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 800 V, V _{GS} = 0 V			25	μΑ
		V _{DS} = 640 V, T _C = 125°C	250		250	7
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 5.8 \text{ mA}$	2.5		4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 29 A		54	60	mΩ
9FS	Forward Transconductance	V _{DS} = 20 V, I _D = 29 A		68		S
YNAMIC CHAI	RACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		11040	14685	pF
C _{oss}	Output Capacitance	1		298	395	pF
C _{rss}	Reverse Transfer Capacitance	1		10		pF
C _{oss}	Output Capacitance	V _{DS} = 480 V, V _{GS} = 0 V, f = 1MHz		147		pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		981		pF
Q _{g(tot)}	Total Gate Charge at 10 V	V _{DS} = 640 V, I _D = 58 A, V _{GS} = 10 V		270	350	nC
Q _{gs}	Gate to Source Gate Charge	- (Note 4)		54		nC
Q _{gd}	Gate to Drain "Miller" Charge	1		100		nC
ESR	Equivalent Series Resistance	f = 1 MHz		0.78		Ω
WITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 58 A, V _{GS} = 10 V		55	120	ns
t _r	Turn-On Rise Time	$R_g = 4.7 \Omega$ (Note 4)		73	156	ns
t _{d(off)}	Turn-Off Delay Time	1		213	436	ns
t _f	Turn-Off Fall Time	1		72	154	ns
OURCE-DRAII	N DIODE CHARACTERISTICS	•				
I _S	Maximum Continuous Drain to Source Diode Forward Current				58	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current				174	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 58A			1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 58 A,		850		ns
Q _{rr}	Reverse Recovery Charge	dl _F /dt = 100 A/μs		35		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

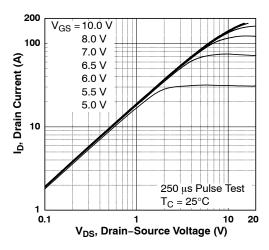


Figure 1. On–Region Characteristics

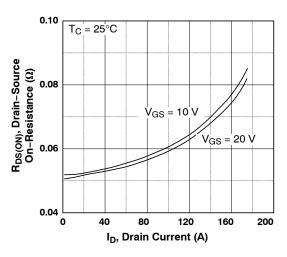


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

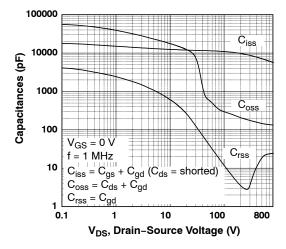


Figure 5. Capacitance Characteristics

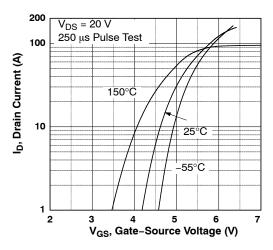


Figure 2. Transfer Characteristics

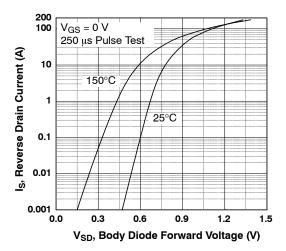


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

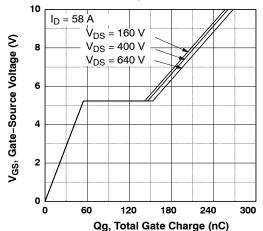


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

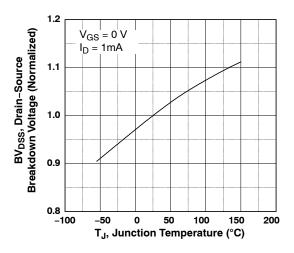


Figure 7. Breakdown Voltage Variation vs. Temperature

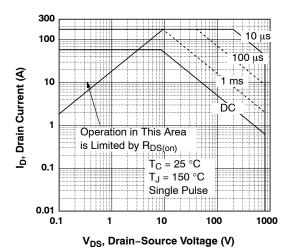


Figure 9. Maximum Safe Operating Area

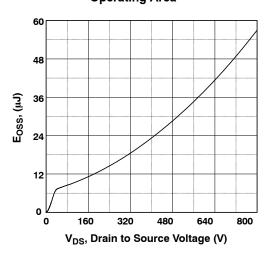


Figure 11. E_{OSS} vs. Drain to Source Voltage

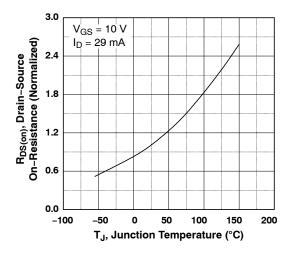


Figure 8. On-Resistance Variation vs. Temperature

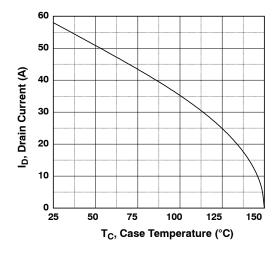


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

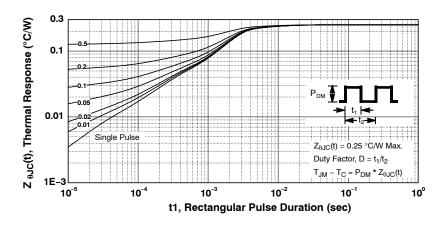


Figure 12. Transient Thermal Response Curve

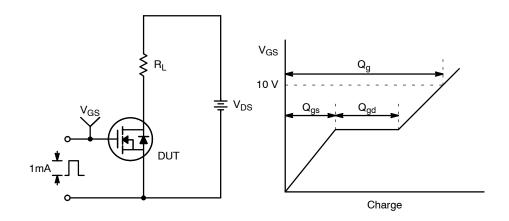


Figure 13. Gate Charge Test Circuit & Waveform

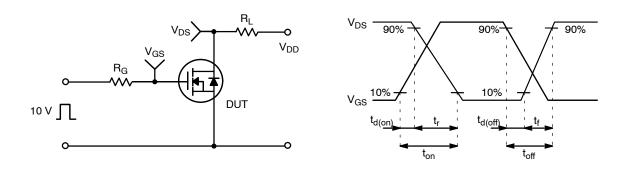


Figure 14. Resistive Switching Test Circuit & Waveforms

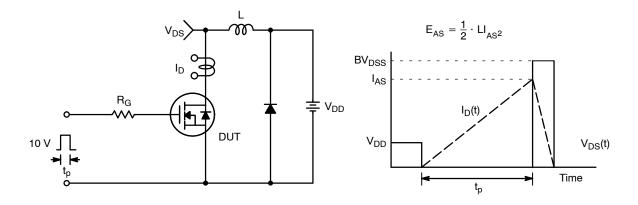
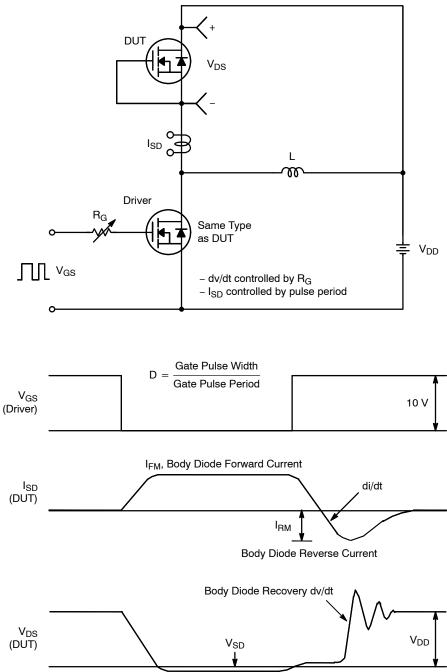


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

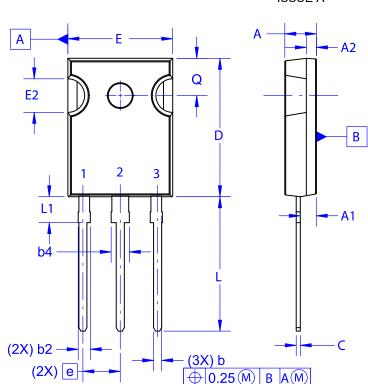


Body Diode Forward Voltage Drop

Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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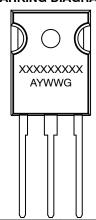
TO-247-3LD CASE 340CH **ISSUE A**





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
 D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC **MARKING DIAGRAM***



XXXX = Specific Device Code

= Assembly Location

WW = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

	DATE	09 OCT 2019
Ø P —		P1 D2
S E1 —	2	D1
		<u>.</u>

DIM	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
A 1	2.29	2.475	2.66	
A2	1.40	1.50	1.60	
D	20.32	20.57	20.82	
Е	15.37	15.62	15.87	
E2	4.96	5.08	5.20	
е	~	5.56	~	
L	19.75	20.00	20.25	
L1	3.69	3.81	3.93	
ØΡ	3.51	3.58	3.65	
Q	5.34	5.46	5.58	
S	5.34	5.46	5.58	
b	1.17	1.26	1.35	
b2	1.53	1.65	1.77	
b4	2.42	2.54	2.66	
С	0.51	0.61	0.71	
D1	13.08	~	~	
D2	0.51	0.93	1.35	
E1	12.81	~	~	
ØP1	6.61	6.73	6.85	

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FAN3111ESX FDMC86262P FDMD8530 FEBFL7733A_L53U021A FEBFOD8333 MM74HC138MX MMBZ5233B FOD3120SD
FPAB30BH60B FQP2N80 1.5KE16AG MT9V115EBKSTCH-GEVB NB6L295MNGEVB NB7L1008MNGEVB NC7WZ126K8X
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